

MEG03-005CCC



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September 19, 2008

TO: Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

FROM: Saile Ackerman LLC
Stephen B. Ackerman, Reg. No. 37,761
28 Davis Avenue
Poughkeepsie, NY 12603

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SEP 30 2008

OFFICE OF PETITIONS

SUBJECT: Serial #: 10/796427
File Date: March 9, 2004
Inventor: Lin, M.S.
Examiner: M. Lewis
Art Unit: 2822
Title: Wirebond Pad For Semiconductor Chip Or Wafer

A Request for Continued Examination for the above-mentioned application was filed on July 29, 2008, but with a small entity fee amount. The fee amount paid for the RCE was \$405. Therefore, a total deficiency payment of \$405 is owed and herein enclosed.

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on September 19, 2008.

Signature 
Stephen B. Ackerman, Reg. No. 37,761

Date: September 19, 2008

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The Commissioner is hereby authorized to charge the additional fee of \$405 to
Deposit Account No. 19-0033.

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It is requested that should there be any problems, please call the undersigned
Attorney at (845) 452-5863.

Respectfully submitted,



Stephen B. Ackerman, Reg. No. 37,761

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